Lee Milburn

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EDUCATION

University of Pennsylvania, School of Engineering and Applied Science, Philadelphia, PA

Expected, May 2025

Master of Science in Engineering in Robotics

Northeastern University, College of Engineering, Boston, MA

May 2023

Bachelor of Science in Computer Engineering and Computer Science

GPA: 3.79, Magna Cum Laude

Awards: 1st in ECE Capstone Competition; Fung Leadership Award; PEAK: The Summit Award; Northeastern Achievement Award *Teaching Experience:* Fundamentals of Computer Science 2, Teachers Assistant

RELEVANT EXPERIENCE

Scientific Systems, Woburn, MA

Autonomous Systems Co-op

July 2021 - July 2022

- Developed algorithms for multi-target pursuit-evasion and implemented AI task-determining structures for SRM project
- · Researched modeling search algorithms for optimizing multi-robot task allocation scheduled towards a time horizon

United Electronics Industries, Waltham, MA

Sales Engineer Co-Op

July - December 2020

Benchmark tested UEI's hardware to determine the maximum possible data throughput

BrainQ Technologies, Jerusalem, Israel

Product Intern June – August 2019

Tested EMG physical therapy product and researched start up market for initiating Series B funding

RESEARCH

Vinum-EU, Genova, Italy

Advisor: Dr. Claudio Semini

Guest Researcher at Italian Institute of Technology

July - December 2022

• Developed a navigation stack for a quadruped robot to autonomously navigate a vineyard in an unknown environment

TRASH, Boston, MA

Advisor: Dr. Taskin Padir June 2021 - April 2022

- Undergraduate Researcher at Northeastern University
 - Prototyped an autonomous UAV-UGV system to identify and pick up trash in unknown environments
 - Won first prize in Northeastern's ECE Capstone Competition

ACE-PPE, Boston, MA

Advisor: Dr. Taskin Padir

Undergraduate Researcher at Northeastern University

September 2020 - June 2021

Designed and fabricated autonomous material PPE tests according to industry standards

PUBLICATIONS & CONFERENCES

First Author publication in <u>IEEE-ICARSC</u> 2023; First Author publication and presentation in <u>IRIM</u> 2022; Co-author publication in <u>IEEE-HST</u> 2022; Presented poster in DARS 2022; TRASH <u>manuscript</u> in progress

TECHNICAL SKILLS

Programming Languages: Python, C++, ROS, Java, Bash, SQL, LaTex

Platforms/Tools: Docker, SolidWorks, 3D Printing, Auto-Cad, Simulink, Pspice, Git

Electrical: Digital Multimeter, Oscilloscope, Arduino, Protoboard Circuit Design, Soldering, Wiring